

# APPROVAL SHEET

**RFANT Series – RoHS Compliance**

MULTILAYER CERAMIC ANTENNA

**Halogens Free Product**

2400 ~ 2500 MHz Working Frequency

**P/N: RFANT3216120A1T**

\*Contents in this sheet are subject to change without prior notice.

**FRATRES**

1. Surface Mounted Devices with a small dimension of 3.2 X 1.6 X 1.2 mm<sup>3</sup> meet future miniaturization trend.
2. LTCC process
3. High stability in Temperature / Humidity Change

**APPLICATIONS**

1. 2400 ~ 2500 MHz Working Frequency
2. Bluetooth, Wireless, HomeRF

**CONSTRUCTION**

Top view



PIN	Connection
1	Feeding
2	Identification Mark
3	Soldering terminal

**DIMENSIONS**

Figure	Symbol	Dimension (mm)
	L	3.20 ± 0.20
	W	1.60 ± 0.10
	T	1.20 ± 0.10
	A	0.25 ± 0.15

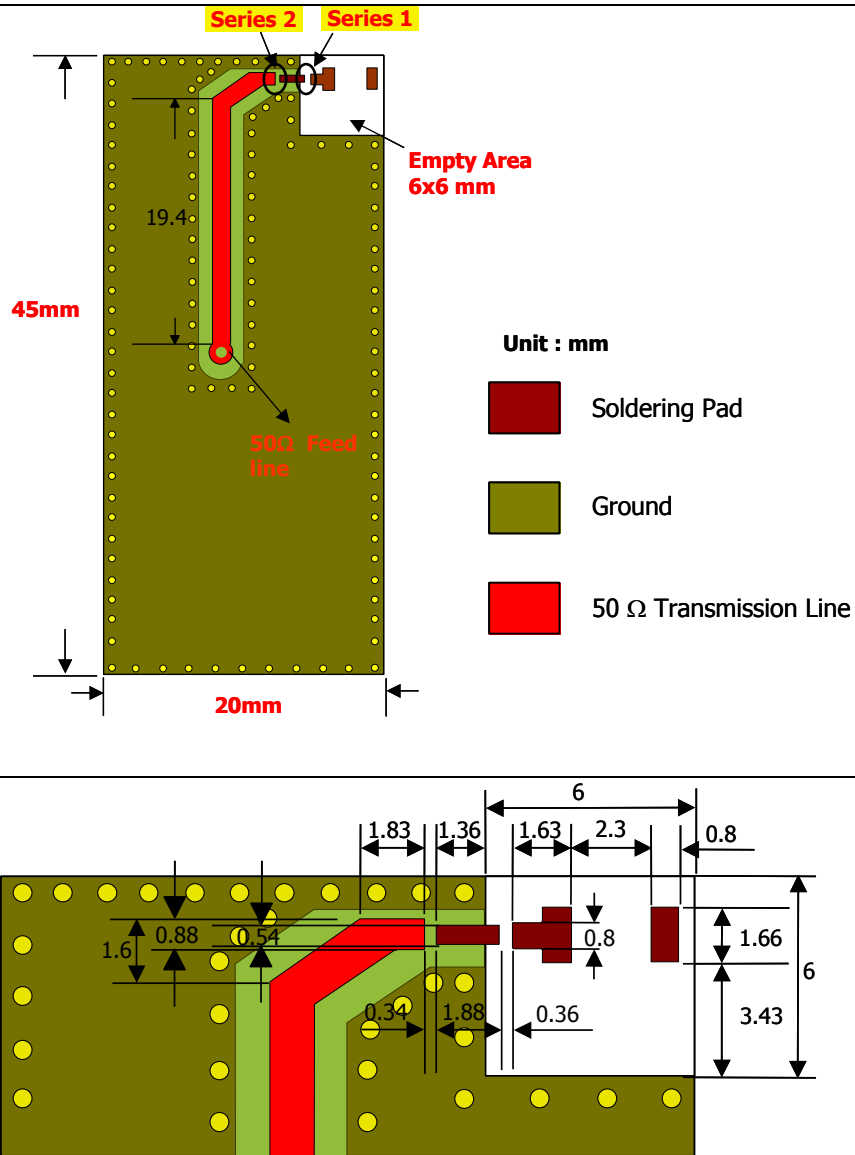
**ELECTRICAL CHARACTERISTICS**

<b>RFANT3216120A1T</b>		<b>Specification</b>
Working Frequency Range		2450 ± 50 MHz
Fc (GHz)		2.5
Gain (dBi)		2 (Typical)
Matching component value	Series 1	2.7nH
	Series 2	-
Power Capacity		3 W max
Maximum Input Power		5 Watts for 5 minutes
Polarization		Linear
Azimuth Beamwidth		Omni-directional
Moisture sensitivity levels		MSL is LEVEL 1 (Refer to : IPC/JEDEC J-STD-020)
HBM ESD		Pass 1KV on all pins (Base on AEC-Q200-002)
MM ESD		Pass 200V (Base on EIA/JESD22-A115)
<b>Operating &amp; Storage Condition (Component)</b>		
Operation Temperature Range: -40℃ ~ +85℃		
Storage Temperature Range: -40℃ ~ +85℃		
<b>Storage Condition before Soldering (Included packaging material)</b>		
Storage Temperature Range: +5 ~ +40℃		
Humidity: 30 to 70% relative humidity		

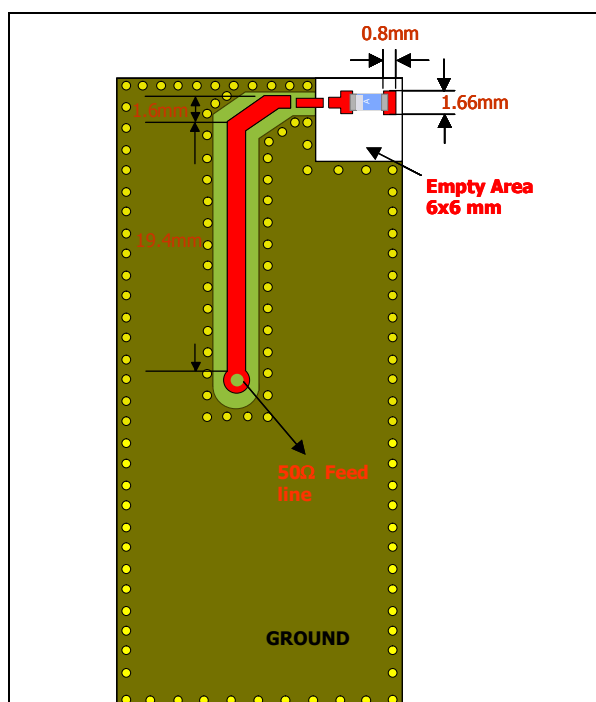
\* This frequency must be adjusted to 2.45GHz with matching circuit.

## SOLDER LAND PATTERN DESIGN

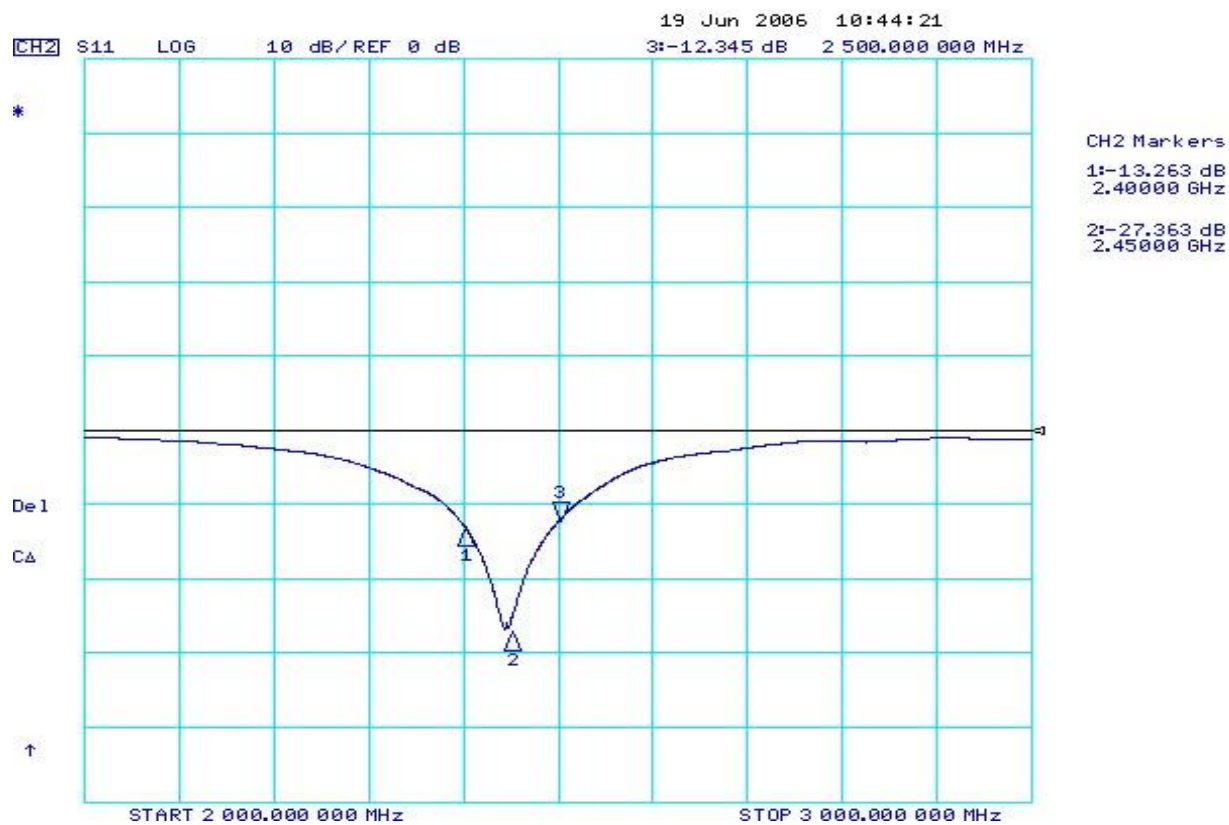
Figure



## Antenna on Test Board ( Thickness 1.2mm)

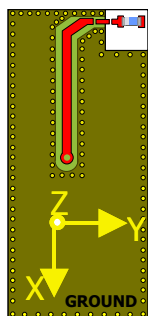


## Antenna S11 on Test Board



**RADIATION PATTERN**

Radiation Pattern and Gain were dependent on measurement board design. The specification of RFANT3216120A1T antenna was measured based on the PCB size and installation position as shown in the below figure Test Board



	Vertical	Horizontal
<b>Y - Z Plane</b>  Average Gain= 0.859 dBi	 Peak Gain = 2.13dBi Average Gain = 0.62 dBi	 Peak Gain= -6.47dBi Average Gain=-11.86dBi
<b>X - Z Plane</b>  Average Gain= -1.804 dBi	 Peak Gain= -7.43 dBi Average Gain= -12.30dBi	 Peak Gain= 1.07 dBi Average Gain= -2.21 dBi
<b>X - Y Plane</b>  Average Gain= -2.365 dBi	 Peak Gain= -9.98 dBi Average Gain= -15.53dBi	 Peak Gain= 1.84 dBi Average Gain= -2.57 dBi

## RELIABILITY TEST

Test item	Test condition / Test method	Specification
Solderability JIS C 0050-4.6 JESD22-B102D	*Solder bath temperature : $235 \pm 5^{\circ}\text{C}$ *Immersion time : $2 \pm 0.5$ sec Solder : Sn3Ag0.5Cu for lead-free	At least 95% of a surface of each terminal electrode must be covered by fresh solder.
Resistance to soldering heat JIS C 0050-5.4	*Preheating temperature : $120\sim 150^{\circ}\text{C}$ , 1 minute. *Solder temperature : $270\pm 5^{\circ}\text{C}$ *Immersion time : $10\pm 1$ sec Solder : Sn3Ag0.5Cu for lead-free Measurement to be made after keeping at room temperature for $24\pm 2$ hrs	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within $-40 \sim 85^{\circ}\text{C}$ . Loss of metallization on the edges of each electrode shall not exceed 25%.
Drop Test JIS C 0044 Customer's specification.	*Height : 75 cm *Test Surface : Rigid surface of concrete or steel. *Times : 6 surfaces for each units ; 2 times for each side.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within $-40 \sim 85^{\circ}\text{C}$ .
Vibration JIS C 0040	*Frequency : $10\text{Hz}\sim 55\text{Hz}\sim 10\text{Hz}(1\text{min})$ *Total amplitude : 1.5mm *Test times : 6hrs.(Two hrs each in three mutually perpendicular directions)	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within $-40 \sim 85^{\circ}\text{C}$ .
Adhesive Strength of Termination JIS C 0051- 7.4.3	*Pressurizing force : 5N (LGA terminal series) ; $5\text{N}(\leq 0603)$ ; $10\text{N}(>0603)$ *Test time : $10\pm 1$ sec	No remarkable damage or removal of the termination.
Bending test JIS C 0051- 7.4.1	The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of about 1 mm/s per second until the deflection becomes 1mm/s and then pressure shall be maintained for $5\pm 1$ sec. Measurement to be made after keeping at room temperature for $24\pm 2$ hours	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within $-40 \sim 85^{\circ}\text{C}$ .

Temperature cycle JIS C 0025	1. 30±3 minutes at -40°C±3°C, 2. 10~15 minutes at room temperature, 3. 30±3 minutes at +85°C±3°C, 4. 10~15 minutes at room temperature, Total 100 continuous cycles Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
High temperature JIS C 0021	*Temperature : 85°C±2°C *Test duration : 1000+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
Humidity (steady conditions) JIS C 0022	*Humidity : 90% to 95% R.H. *Temperature : 40±2°C *Time : 1000+24/-0 hrs. Measurement to be made after keeping at room temperature for 24±2 hrs ※ 500hrs measuring the first data then 1000hrs data	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
Low temperature JIS C 0020	*Temperature : -40°C±2°C *Test duration : 1000+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.



### SOLDERING CONDITION

Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 2.  
 This product could sustain by reflow process three times, and the temperature below 260°C.

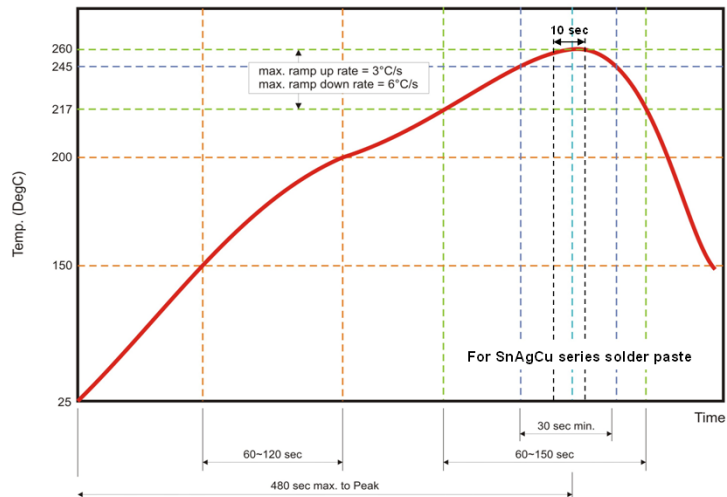


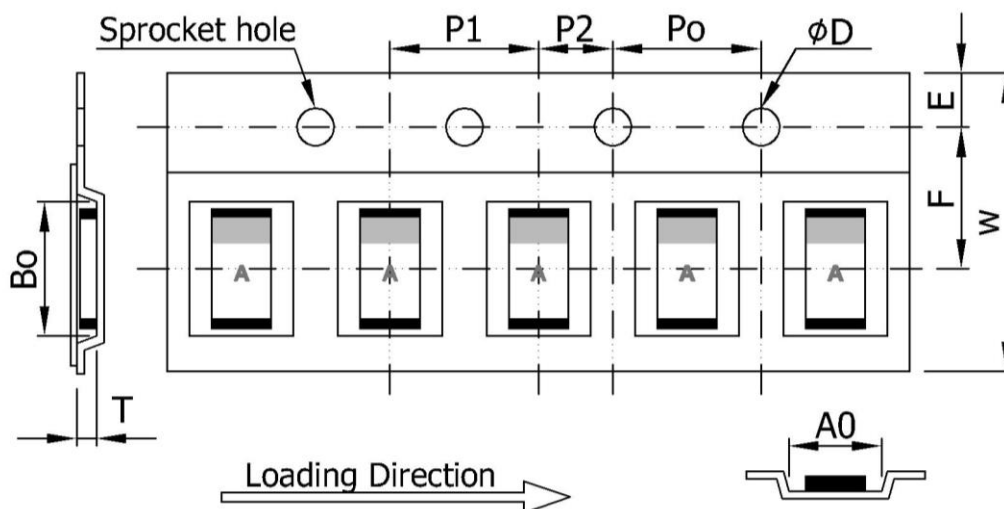
Fig 2. Infrared soldering profile

### ORDERIND CODE

RF	ANT	321612	0	A	1	T
<b>Walsin</b> RF device	<b>Product code</b> ANT : Antenna	<b>Dimension code</b> Per 2 digits of Length, Width, Thickness : e.g. : 321612 = Length 32, Width 16, Thickness 12	<b>Unit of dimension</b> 0 : 0.1 mm 1 : 1.0 mm	<b>Application</b> A : 2.4GHZ ISM Band	<b>Specification</b> Design Code	<b>Packing</b> T : 7" Reeled

Minimum Ordering Quantity: 2000 pcs per reel.

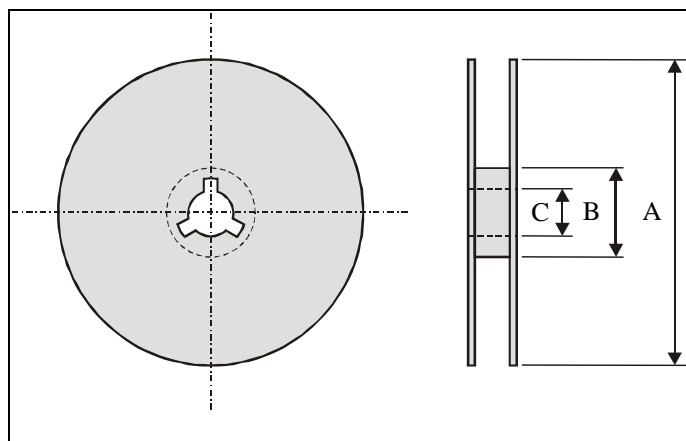
### PACKAGING



Plastic Tape specifications (unit :mm)

Index	Ao	Bo	$\Phi D$	T	W
Dimension (mm)	$1.81 \pm 0.10$	$3.42 \pm 0.10$	$1.55 \pm 0.05$	$1.26 \pm 0.10$	$8.00 \pm 0.10$
Index	E	F	Po	P1	P2
Dimension (mm)	$1.75 \pm 0.10$	$3.50 \pm 0.05$	$4.00 \pm 0.10$	$4.00 \pm 0.10$	$2.00 \pm 0.10$

## Reel dimensions



Index	A	B	C
Dimension (mm)	Φ178	Φ60.0	Φ13.5

Typing Quantity: 2000 pieces per 7" reel

## CAUTION OF HANDLING

## Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects, which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Medical equipment
- (5) Disaster prevention / crime prevention equipment
- (6) Traffic signal equipment
- (7) Transportation equipment (vehicles, trains, ships, etc.)
- (8) Applications of similar complexity and /or reliability requirements to the applications listed in the above.

## Storage condition

- (1) Products should be used in 6 months from the day of WALSIN outgoing inspection.
- (2) Storage environment condition.

- Products should be storage in the warehouse on the following conditions.
- Temperature : +5 to +40℃
- Humidity : 30 to 70% relative humidity
- Don't keep products in corrosive gases such as sulfur. Chlorine gas or acid or it may cause oxidization of electrode, resulting in poor solderability.
- Products should be storage on the palette for the prevention of the influence from humidity, dust and so on.
- Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
- Products should be storage under the airtight packaged condition.